Features and Benefits

PROPRIETARY HONEYWELL TECHNOLOGY

Combines high sensitivity with high overpressure and burst pressure while providing industry leading stability—performance factors that are difficult to achieve in the same product; this gives the customer more flexibility in sensor implementation and reduces the customer design requirements for protecting the sensor without sacrificing the ability to sense very small changes in pressure.

PROTECTED BY MULTIPLE GLOBAL PATENTS

INDUSTRY-LEADING LONG-TERM STABILITY

Even after long-term use and thermal extremes, the sensor's stability remains best in class:

- Minimizes system calibration needs.
- Improves system performance.
- Helps support system uptime by minimizing the need to service or replace the sensor during its application life.

TOTAL ERROR BAND (TEB)

Honeywell specifies TEB—the most comprehensive, clear, and meaningful measurement—that provides the sensor's true performance over a compensated range of -20 °C to 85 °C [-4 °F to 185 °F] (see Figure 1):

- Minimizes individually testing and calibrating every sensor, decreasing manufacturing time and process costs.
- Improves system accuracy.
- Provides enhanced sensor interchangeability—there is minimal part-to-part variation in accuracy.

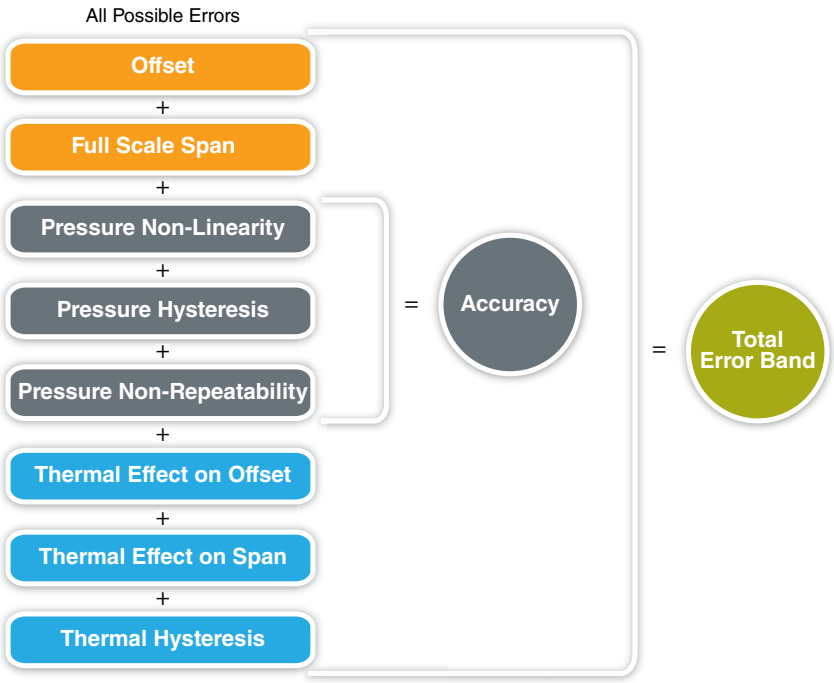

Figure 1. TEB Components for TruStability® Board Mount Pressure Sensors

Features and Benefits

INDUSTRY-LEADING ACCURACY

Extremely tight accuracy of ±0.25 %FSS BFSL (Full Scale Span Best Fit Straight Line) reduces software needs to correct system inaccuracies, minimizing system design time:

- Avoids additional customer calibration.
- Helps to improve system efficiency.
- Often simplifies software development.

HIGH BURST PRESSURES

- Promotes system reliability and reduces potential system downtime.
- Can simplify the design process.

HIGH WORKING PRESSURE RANGES

Allows ultra-low pressure sensors to be used continuously well above the calibrated pressure range.

INDUSTRY-LEADING FLEXIBILITY

Modular, flexible design with many package styles (with the same industry-leading stability), pressure ports, and options simplify integration into the device manufacturer's application.

WIDE VARIETY OF PRESSURE RANGES

From ±1.6 mbar to ±10 bar | ±160 Pa to ±1 MPa | ±0.5 inH_2O to ±150 psi provide support for many unique applications.

MEETS IPC/JEDEC J-STD-020D.1 MOISTURE SENSITIVITY LEVEL 1 REQUIREMENTS

- Allows the customer to avoid the thermal and mechanical damage during solder reflow attachment and/or repair that lesser rated products would incur.
- Allows unlimited floor life when stored as specified (≤30 ºC/85 %RH), simplifying storage and reducing scrap.
- Never requires lengthy bakes prior to reflow.
- Stable and usable shortly after reflow process allows for lean manufacturing.

OPTIONAL INTERNAL DIAGNOSTIC FUNCTIONS

- May reduce the need for redundant sensors in the system.
- Detects most internal failures including burst sensors.

ENERGY EFFICIENT

Extremely low power consumption (less than 10 mW, typ.):

- Reduces system power requirements.
- Enables extended battery life.
- Optional sleep mode available upon special request.